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 Members of the Texas Instruments Widebus ™ Family 	54AC16543 74AC16543 (TOP)	DL PACKAGE
3-State True Outputs		
Flow-Through Architecture Optimizes		56 1 <u>0EBA</u>
PCB Layout	1LEAB	55 1LEBA
 Distributed V_{CC} and GND Pin Configuration 	1CEAB	54 1CEBA
Minimizes High-Speed Switching Noise	GND 4	53 GND
● EPIC ™ (Enhanced-Performance Implanted	1A1 <u>5</u>	52 1B1
CMOS) 1-µm Process	1A2 6	51 1B2
 500-mA Typical Latch-Up Immunity at 	V _{CC} 7	50 V _{CC}
125°C	1A3 8	49 1B3
Package Options Include Plastic 300-mil	1A4 9	48 1B4
Shrink Small-Outline (DL) Package Using		47 1B5
25-mil Center-to-Center Pin Spacings and	GND 11 1A6 12	
380-mil Fine-Pitch Ceramic Flat (WD)		45 1B6 44 1B7
Package Using 25-mil Center-to-Center Pin	1A7 📘 13 1A8 📘 14	44 1 1B7 43 1 1B8
Spacings	2A1 15	43 1 1B8 42 2B1
	2A1 115 2A2 16	41 2B2
description	2A2 1 16 2A3 1 17	40 2B3
	GND 18	40 263 39 GND
The 'AC16543 are 16-bit registered transceivers	2A4 1 19	38 2B4
that contain two sets of D-type latches for	2A4 1 19 2A5 20	37 2B5
temporary storage of data flowing in either direction. They can be used as two 8-bit	2A3 1 20 2A6 21	36 2B6
direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate	V_{CC}	35 V _{CC}
latch-enable (LEAB or LEBA) and output-enable	2A7 23	34 2B7
(OEAB or OEBA) inputs are provided for each	2A8 24	33 2B8
register to permit independent control in either	GND 25	32 GND
direction of data flow.	2CEAB	31 2CEBA
	2LEAB 27	30 2LEBA
The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. Having	20EAB 28	29 20EBA

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. Having

CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-to-high transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

The 74AC16543 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16543 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74AC16543 is characterized for operation from -40°C to 85°C.



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54AC16543, 74AC16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS125B – MARCH 1990 – REVISED APRIL 1996

FUNCTION TABLE[†] (each 8-bit section)

(0.001.0.000.001)								
	INPUTS							
CEAB	LEAB	OEAB	Α	В				
Н	Х	Х	Х	Z				
Х	Х	Н	Х	Z				
L	Н	L	Х	в ₀ ‡				
L	L	L	L	L				
L	L	L	Н	Н				

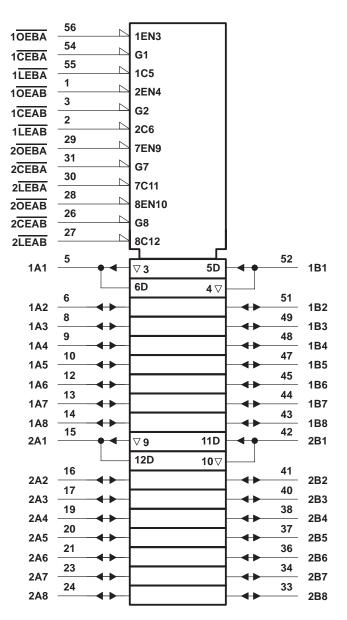
[†] A-to-B data flow is shown: <u>B-to-A flow control is</u> the same except that it uses CEBA, LEBA, and OEBA.
 [‡] Output level before the indicated steady-state input

conditions were established



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logic symbol[†]

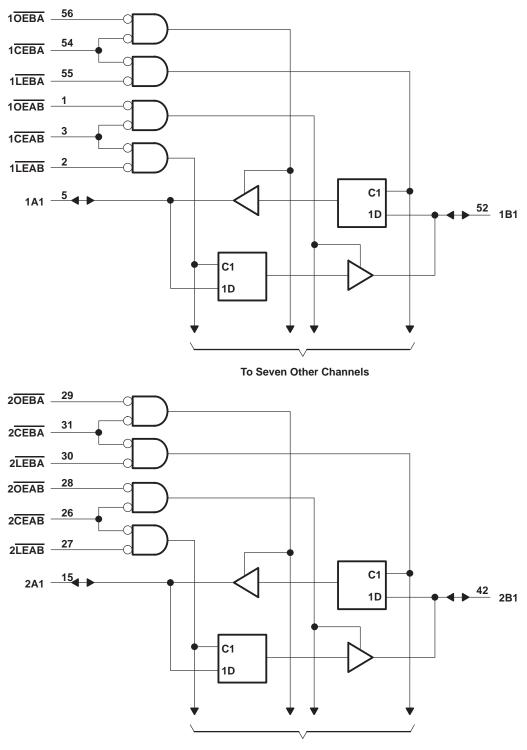


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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logic diagram (positive logic)



To Seven Other Channels



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

	5 V 5 V mA mA mA mA
Maximum power package dissipation at $T_A = 55^{\circ}C$ (in still air)(see Note 2): DL package	

⁺ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 3)

			54	AC1654	3	74AC16543			
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage		3	5	5.5	3	5	5.5	V
		$V_{CC} = 3 V$	2.1			2.1			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V
		$V_{CC} = 5.5 V$	3.85			3.85			
		VCC = 3 V			0.9			0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5 V$		4	1.35			1.35	V
		$V_{CC} = 5.5 V$		EL	1.65			1.65	
VI	Input voltage		0	4	VCC	0		VCC	V
VO	Output voltage		0	5	VCC	0		VCC	V
		VCC = 3 V	40	2	-4			-4	
ЮН	High-level output current	$V_{CC} = 4.5 V$	PPC -		-24			-24	mA
		$V_{CC} = 5.5 V$			-24			-24	
		$V_{CC} = 3 V$			12			12	
IOL	Low-level output current	$V_{CC} = 4.5 V$			24			24	mA
		V _{CC} = 5.5 V			24			24	
$\Delta t/\Delta v$	Input transition rise or fall rate		0		10	0		10	ns/V
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				T/	A = 25°C	;	54AC1	6543	74AC1			
PA	RAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX		
		I _{OH} = -50 μA	3 V	2.9			2.9		2.9			
			4.5 V	4.4			4.4		4.4			
			5.5 V	5.4			5.4		5.4			
∨он		$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		2.48		V	
			4.5 V	3.94			3.8	V	3.8			
		$I_{OL} = -24 \text{ mA}$	5.5 V	4.94			4.8	VIE	4.8			
		I _{OH} = -75 mA [†]	5.5 V				3.85	RE	3.85			
		l _{OL} = 50 μA	3 V			0.1	7	0.1		0.1		
			4.5 V			0.1	UCC	0.1		0.1		
			5.5 V			0.1	20	0.1		0.1		
VOL		I _{OL} = 12 mA	3 V			0.36	44	0.44		0.44	V	
			4.5 V			0.36		0.44		0.44		
		I _{OL} = 24 mA	5.5 V			0.36		0.44		0.44		
		I _{OL} = 75 mA [†]	5.5 V					1.65		1.65		
Ιį	Control inputs	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μA	
I _{OZ}	A or B ports	$V_{O} = V_{CC}$ or GND	5.5 V			±0.5		±5		±5	μA	
ICC		$V_{I} = V_{CC} \text{ or GND}, I_{O} = 0$	5.5 V			8		80		80	μA	
Ci	Control inputs	$V_I = V_{CC}$ or GND	5 V		3						pF	
Cio	A or B ports	$V_{O} = V_{CC} \text{ or } GND$	5 V		11.5						pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		54AC16543 74AC16543				
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
tw	Pulse duration, LEAB or LEBA low	5		5	12.0	5		ns
t _{su}	Setup time, data before LEAB or LEBA ↑	1		D	UIF.	1		ns
t _h	Hold time, data after \overline{LEAB} or \overline{LEBA} \uparrow	3.5		3.5		3.5		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		54AC16543 74AC16543				
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
tw	Pulse duration, LEAB or LEBA low	4		4	1. C	4		ns
t _{su}	Setup time, data before LEAB or LEBA ↑	1		0	11F	1		ns
th	Hold time, data after \overline{LEAB} or \overline{LEBA} \uparrow	3		3		3		ns



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

00	,	, (0	,						
DADAMETED	FROM	то	T	T _A = 25°C		54AC16543		74AC16543		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	B or A	3.2	8.6	12.5	3.2	13.9	3.2	13.9	ns
^t PLH	LEBA or LEAB	A ar D	4.6	11.8	16	4.6	18	4.6	18	
^t PHL		A or B	4.6	11.3	15.4	4.6	16.8	4.6	16.8	ns
^t PZH	CEBA or CEAB		3.7	10	14	3.7	15.8	3.7	15.8	
^t PZL		A or B	4.6	12.7	17.7	4.6	19.8	4.6	19.8	ns
^t PHZ	CEBA or CEAB	A ar D	4.7	7.8	10.1	4.7	10.8	4.7	10.8	
^t PLZ	CEBA OF CEAB	A or B	4.3	7.3	9.7	43	10.4	4.3	10.4	ns
^t PZH		A at D	3.5	9.7	13.9	3.5	15.7	3.5	15.7	
^t PZL	OEBA or OEAB	A or B	4.5	12.5	17.6	4.5	19.7	4.5	19.7	ns
^t PHZ	OEBA or OEAB	A or B	4.8	7.5	9.6	4.8	10.2	4.8	10.2	00
^t PLZ		AUB	4.1	6.8	9.2	4.1	9.8	4.1	9.8	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

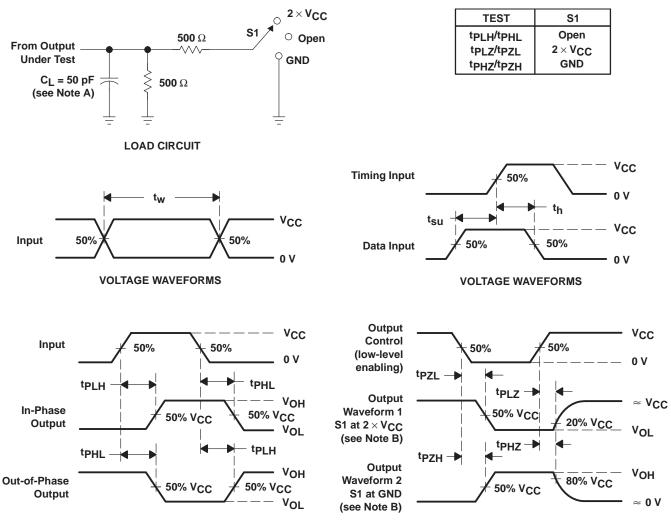
DADAMETED	FROM	FROM TO		₄ = 25°C	;	54AC1	6543	74AC16543		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	4 D	Dank	2.7	5.2	7.8	2.7	8.8	2.7	8.8	
^t PHL	A or B	B or A	2.9	5.5	8.3	2.9	9.2	2.9	9.2	ns
^t PLH	LEBA or LEAB	A D	3.9	7	10.2	3.9	11.5	3.9	11.5	
^t PHL		A or B	3.7	6.7	9.9	3.7	10.9	3.7	10.9	ns
^t PZH	CEBA or CEAB	A	3	5.8	8.7	3	9.8	3	9.8	
^t PZL		A or B	3.6	6.7	10.3	3.6	11.5	3.6	11.5	ns
^t PHZ		A	4.2	6.5	8.7	4.2	9.3	4.2	9.3	
^t PLZ	CEBA or CEAB	A or B	4	5.9	8.2	Ž4	8.8	4	8.8	ns
^t PZH		A D	2.9	5.6	8.5	2.9	9.6	2.9	9.6	
^t PZL	OEBA or OEAB	A or B	3.5	6.6	10.2	3.5	11.3	3.5	11.3	ns
^t PHZ	OEBA or OEAB	A or B	4.2	6.3	8.4	4.2	8.9	4.2	8.9	
^t PLZ		AUIB	3.7	5.6	7.9	3.7	8.4	3.7	8.4	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER			TEST CON	TYP	UNIT	
	Dower dissinction conscitance per transcriver	Outputs enabled		f = 1 MHz	53	~
C _{pd} Power dissipation capacitance per transceiver		Outputs disabled	C _L = 50 pF,		11	pF



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PARAMETER MEASUREMENT INFORMATION

VOLTAGE WAVEFORMS

NOTES: A. CI includes probe and jig capacitance.

VOLTAGE WAVEFORMS

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_Q = 50 Ω , t_f = 3 ns, t_f = 3 ns.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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